

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SHIN-CHENG LIN	03/09/2016
WEN-HSIN LIN	03/09/2016
YU-HAO HO	03/09/2016
YU-LUNG CHIN	03/09/2016
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<b>City:</b>	HSINCHU
<b>State/Country:</b>	TAIWAN
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15075726
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<b>ATTORNEY DOCKET NUMBER:</b>	0941-3363PUS1
<b>NAME OF SUBMITTER:</b>	DERYA SEVINC
<b>SIGNATURE:</b>	/Derya Sevinc/
<b>DATE SIGNED:</b>	03/21/2016
<b>Total Attachments: 2</b>	
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## ASSIGNMENT

WHEREAS, Shin-Cheng LIN, Wen-Hsin LIN, Yu-Hao HO, and Yu-Lung CHIN

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: HIGH-VOLTAGE SEMICONDUCTOR STRUCTURE

Filed: \_\_\_\_\_ Serial No. \_\_\_\_\_

Executed on: \_\_\_\_\_

WHEREAS, Vanguard International Semiconductor Corporation of 123, Park Ave-3rd, Science - Based Industrial Park, Hsinchu, Taiwan 30077, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Shin-Cheng LIN  
Shin-Cheng LIN

3/9/2016  
Date

Wen-Hsin LIN  
Wen-Hsin LIN

03/09/2016  
Date

Yu-Hao HO  
Yu-Hao HO

03/09/2016  
Date

**ASSIGNMENT**

Yu-Lung Chn  
Yu-Lung CHIN

3/9/2016  
Date